e

RoHS

COMPLIANT

HALOGEN FREE

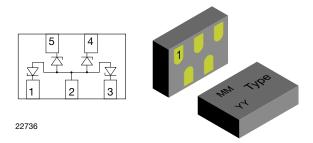
GREEN



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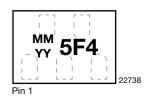
4-Line BUS-Port ESD Protection Array - Flow Through Design



FEATURES

- Compact chip level page CLP1007-5L
- Length = 1 mm; width = 0.7 mm; height = 0.27 mm
- 4-lines, unidirectional ESD protection array
- Low leakage current I_R < 0.1 μA
- Low capacitance at V_R = 0 V = 0.9 pF (typ.)
- Ideal for high speed data line like
 - HDMI, DisplayPort, eSATA
 - USB, 1394/firewire
 - Thunderbolt
- ESD immunity acc. IEC 61000-4-2
 - ± 15 kV contact discharge
 - ± 15 kV air discharge
- e4 precious metal (e.g. Ag, Au, NiPd, NiPdAu) (no Sn)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

MARKING



5F4 = type code MM = date code month YY = date code year

LINKS TO ADDITIONAL RESOURCES





ORDERING INFORMATION					
DEVICE NAME	ORDERING CODE	TAPED UNITS PER REEL (8 mm TAPE ON 7" REEL)	MINIMUM ORDER QUANTITY		
VBUS54FD-SD1	VBUS54FD-SD1-G4-08	10 000	10 000		

PACKAGE DATA					
DEVICE NAME	PACKAGE NAME	TYPE CODE	WEIGHT	MOISTURE SENSITIVITY LEVEL	SOLDERING CONDITIONS
VBUS54FD-SD1	CLP1007-5L	5F4	0.45 mg	MSL level 1 (according J-STD-020)	Peak temperature max. 260 °C

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Peak pulse current	Acc. IEC 61000-4-5; $t_P = 8/20 \mu s$; single shot	4-5; t _P = 8/20 µs; single shot		Α
Peak pulse power	Acc. IEC 61000-4-5; t _P = 8/20 μs; single shot	P _{PP}	45	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V	± 15	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses	V_{ESD}	± 15	κν
Operating temperature	Junction temperature	TJ	-40 to +125	°C
Storage temperature		T _{STG}	-55 to +150	°C

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(T _{amb} = 25 °C, unless otherwise specified) PARAMETER TEST CONDITIONS/REMARKS SYMBOL MIN. TYP. MAX.						
Protection paths	Number of lines which can be protected	N _{channel}	-	-	4	UNIT
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	5.5	V
Reverse voltage	at I _R = 0.1 μA	V_{R}	5.5	-	-	V
Reverse current	at V _{RWM} = 5.5 V	I _R	-	< 1 nA	0.1	μΑ
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	6.9	7.5	8.7	V
Reverse clamping voltage	at I _{PP} = 1 A	V _C	-	9.5	11	V
	at I _{PP} = I _{PPM} = 3 A	V _C	-	12.9	15	V
Forward alamaina valtaga	at I _{PP} = 1 A	V_{F}	-	1.8	2.2	V
Forward clamping voltage	at I _{PP} = 3 A	V_{F}	-	3	4	V
Capacitance	at $V_R = 0 V$; $f = 1 MHz$)	-	0.9	1	pF
	at $V_R = 3.3 \text{ V}$; $f = 1 \text{ MHz}$	C _D	-	0.9	1	pF
Clamping voltage	Transmission Line Pulse (TLP); $t_p = 100 \text{ ns}$, $I_{TLP} = 8 \text{ A}$	V _{C-TLP}	-	18	-	V
Clamping voltage	Transmission Line Pulse (TLP); $t_p = 100 \text{ ns}$, $I_{TLP} = 16 \text{ A}$	V _{C-TLP}	-	24	-	V
Dynamic resistance Transmission Line Pulse (TLP); t _p = 100 ns		V_{C-TLP}	-	0.93	-	Ω

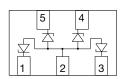
APPLICATION NOTE

The **VBUS54FD-SD1** is a four-line ESD protection device with the characteristic of a Z-diode with a high ESD immunity and a very low capacitance which makes it usable for high frequency applications like USB 2.0, USB 3.0 or HDMI.

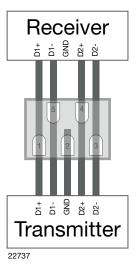
With the **VBUS54FD-SD1** four high speed data lines can be protected against transient voltage signals like ESD (electro static discharge). Connected to the data line (pin 1, 3 and pin 4, 5) and to ground (pin 2) negative transients will be clamped close below the ground level while positive transients will be clamped close above the 5.5 V working range. The clamping behavior of the **VBUS54FD-SD1** is bidirectional but asymmetrical (**BiAs**) and so it offers the best protection for applications running up to 5.5 V.

Pin configuration:

- Pin 2 is the central ground pin and has to be connected to ground
- Pin 1, 3 and 4, 5 are the inputs for the data lines D₁₊ and D₁₋ and D₂₊ and D₂₋



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FLOW THROUGH DESIGN

Modern digital transmission lines can be clocked up to 480 Mbit/s (USB 2.0) or 1.65 Gbit/s (HDMI).

At such high data rates the transmission lines like cables or the line traces on the PCBs have to be very homogeneous regarding their surge impedance. This requires well defined trace dimensions as trace width and distance which have to be calculated depending on the requested surge impedance (e.g. $50~\Omega$) and the PCB material and layer dimensions. Any device connected to the data lines - like ESD protection devices - have to be connected with minimal changes in these trace dimensions and distances.

With the package in the so called "Flow Through Design" this is possible. The lines are running straight along the PCB while the **VBUS54FD-SD1** is placed on top without any vias or loops.

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TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

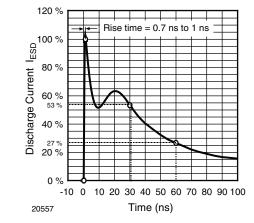


Fig. 1 - ESD Discharge Current Wave Form acc. IEC 61000-4-2 (330 Ω /150 pF)

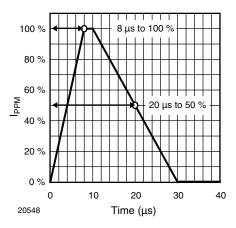


Fig. 2 - 8/20 µs Peak Pulse Current Wave Form acc. IEC 61000-4-5

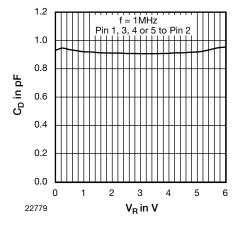


Fig. 3 - Typical Capacitance C_D vs. Reverse Voltage V_R

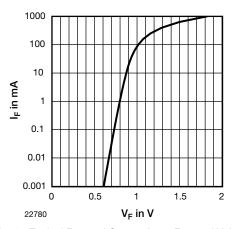


Fig. 4 - Typical Forward Current I_{F} vs. Forward Voltage V_{F}

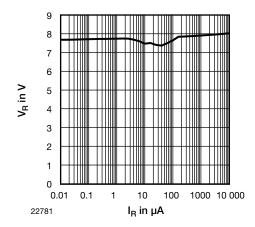


Fig. 5 - Typical Reverse Voltage V_R vs. Reverse Current I_R

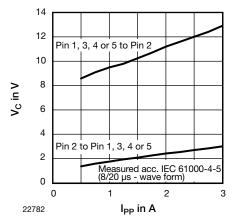


Fig. 6 - Typical Peak Clamping Voltage V_{C} vs. Peak Pulse Current I_{PP}

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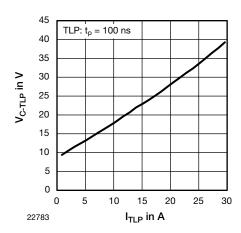
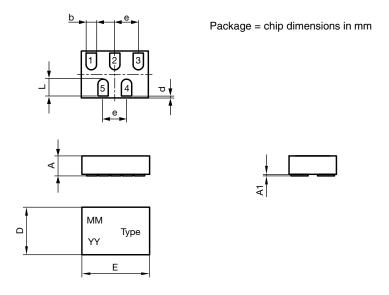
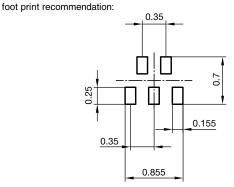


Fig. 7 - Typical Clamping Performance at 100 ns Transmission Line Pulse (TLP)

PACKAGE DIMENSIONS in millimeters: CLP1007-5L



	Millimeters		
	min.	max.	
Α	0.25	0.29	
A1	-	0.02	
b	0.13	0.17	
D	0.68	0.73	
E	0.98	1.03	
е	0.35		
L	0.23	0.27	
Radius	0.075		
d	0.03		



Footprint and soldering recommendation:

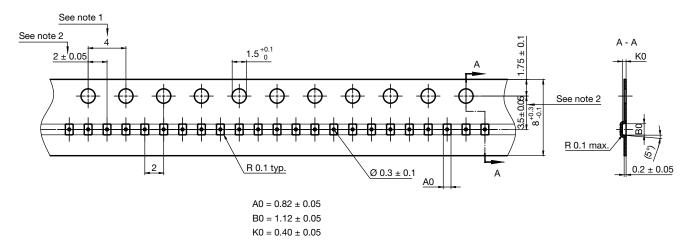
please see Application Note: www.vishay.com/doc?85917

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CARRIER TAPE in millimeters: **CLP1007-5L**



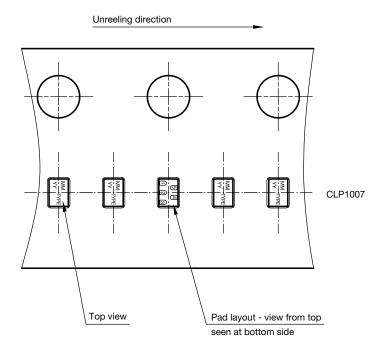
Notes:

- 1. 10 Sprocket hole pitch cumulative tolerance ± 0.2
- 2. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole
- 3. A0 and B0 are calculated on a plane at a distance "R" above the bottom of the pocket

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ORIENTATION IN CARRIER TAPE: CLP1007-5L



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